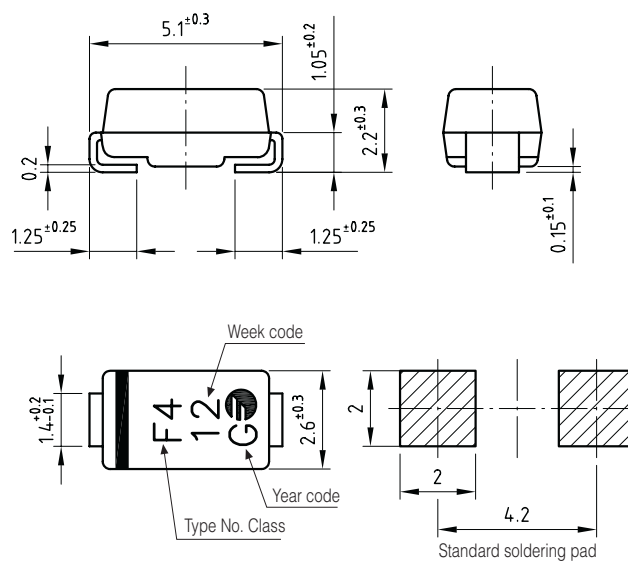



1 Amp. Surface Mounted Glass Passivated Ultrafast Efficient Rectifier

Dimensions in mm. 	CASE: SMA/DO-214AC	Voltage 200 V	Current 1.0 A
			<ul style="list-style-type: none"> • Glass passivated junction • High current capability • The plastic material carries U/L 94 V-0 • Low profile package • Easy pick and place • High temperature soldering 260 °C 10 sec
MECHANICAL DATA Terminals: Solder plated, solderable per IEC 68-2-20. Standard Packaging: 4 mm. tape (EIA-RS-481). Weight: 0.064 g.			

Maximum Ratings and Electrical Characteristics at 25 °C

		FUES1DS
Marking Code		U9
V_{RRM}	Maximum Recurrent Peak Reverse Voltage (V)	200
V_{RMS}	Maximum RMS Voltage (V)	140
V_{DC}	Maximum DC Blocking voltage (V)	200
$I_{F(AV)}$	Forward current at $T_L = 75\text{ °C}$	1.0 A
I_{FSM}	8.3 ms. peak forward surge current (Jedec Method)	30 A
V_F	Max. Instantaneous Forward Voltage Drop at 1.0 A at 0.6 A	0.920 V
		0.865 V
I_R	Maximum DC Reverse Current $T_a = 25\text{ °C}$ at Rated DC Blocking Voltage	2 μ A
	$T_a = 100\text{ °C}$	100 μ A
	at 10V DC Blocking Voltage $T_a = 25\text{ °C}$	200 nA
	at 10V DC Blocking Voltage $T_a = 100\text{ °C}^*$	1 μ A
T_{rr}	Typical Reverse Recovery Time (0.5/1/0.25A)	25 ns
C_j	Typical Junction Capacitance (1MHz; -4V)	8 pF
$R_{th(j-l)}$	Typical Thermal Resistance	27 °C/W
$R_{th(j-a)}$	(5x5 mm ² x 130 μ Copper Area)	75 °C/W
$T_j - T_{stg}$	Operating Junction and Storage Temperature Range	-55 to + 150 °C

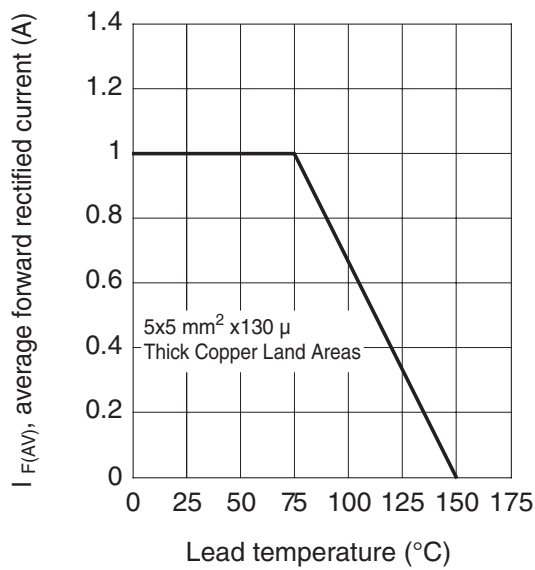
* Each batch is tested and certified to meet an AQL = 0.1% for this parameter.

Electrical Characteristics at $T_j = -40\text{ }^\circ\text{C}$ to $+150\text{ }^\circ\text{C}$

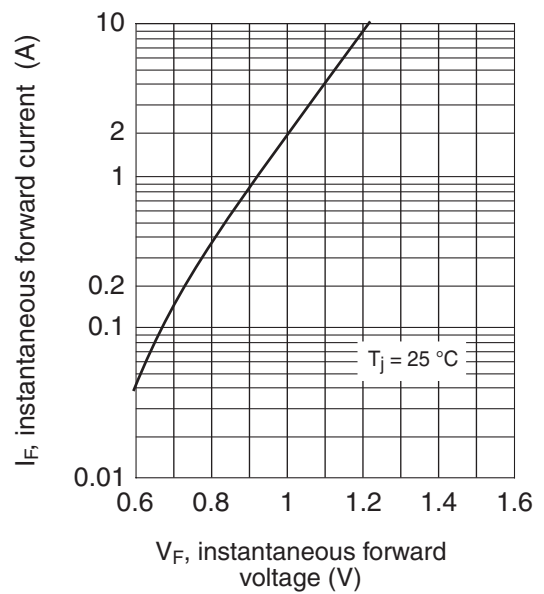
V_F	Max. forward voltage drop at $I_F = 1\text{ A}$	1.05 V
I_R	Maximum DC Reverse Current at rated DC Blocking Voltage	1500 μA

Rating And Characteristic Curves

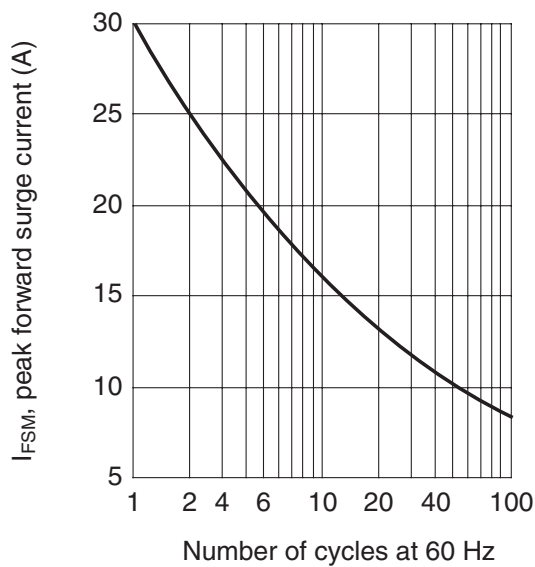
FORWARD CURRENT DERATING CURVE



TYPICAL FORWARD CHARACTERISTIC



MAXIMUM NON REPETITIVE PEAK FORWARD SURGE CURRENT



TYPICAL JUNCTION CAPACITANCE

